# Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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<u>Open</u>

QB-Programmer : V2.00 Firmware : V4.00

Name : 78F9222 prm Version : V1.02

 Name
 SAMPLE.HEX

 Date
 : 2006/02/24 21:13:08

 Chksum
 : 223Eh

 Area
 : 000000h-007FFFh

Name : Firmware:

Type Chksum Area

Cor Port : UART-ch0 Pulse : 0 Speed : 115200bps Range : Chip Freq. : 8.00MHz Multiply : 1.00

Progra

Parameter f

File checksu

Connection to devic : UART-ch0

Load file

Go to STEP 6

Device

• Cancel

28

File name: ".rec;\*.s;\*.hex

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🚆 QB-Programme

File Device Hel

>QB-Programmer startup... >Command standby

Device Setup arameter File Read PASS.

Open Load File uccess read HEX file

Files of type: S-rec / Hex files (\*.rec;\*.s;\*.hex)

#### STEP 6 **Ready for Programming!**

<6> Click the view icon to run Autoprocedure (EPV).

If "Blank check before Erase" is checked during <3> in STEP5 the writing will be executed after automatic blank check.

The mode LED on the MINICUBE2 flashes yellow during execution. When the command execution is completed normally, the mode LED glows green and the following window appears.



## **Programming is completed!**

If an err	If an error occurs, communication with the target device may have failed.						
See	Troubleshooting						
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#### Troubleshooting

#### □ Trouble During Setup

 When the MINICUBE2 is connected to the host machine via a USB interface. the driver is not recognized by Plug and Play.

Cause: The USB connector may not be inserted properly into the USB port of the host machine.

- Action: Check that the USB connector is fully inserted into the USB port of the PC. Alternatively, disconnect the USB connector, then insert the USB connector again later.
- The USB driver file cannot be found at a specified location.

Cause: The USB driver may not have been installed normally.

Action: Refer to CHAPTER 2 SOFTWARE INSTALLATION in QB-Programmer Operation User's Manual (U18527E) and reinstall the USB driver If the file is requested by Plug and Play, specify the following path for the USB driver.

C:\Program Files\NEC Electronics Tools\MQB2ALL

- The MINICUBE2 is connected to the host machine but the Power LED on the MINICUBE2 is not turned on.
- Cause: The USB port of the MINICUBE2 or the host machine may have a defect.
- Action: Check a defect of the MINICUBE2 using the MINICUBE2 diagnostic tool. If a defect is found, consider repair. If there is no defect, try connecting the MINICUBE2 to another machine.

• The "Add New Hardware Wizard" screen is displayed when the MINICUBE2 is connected to a PC.

Cause: If the USB connector of the MINICUBE2 is not inserted into the USB port during installation but into another USB port, the MINICUBE2 may be recognized as a new hardware item.

Action: Select "Install the software automatically [recommended]" and install the USB driver

### □ Trouble During Operation

#### Communication with the target device is not possible

- Cause 1: The driver may not be correctly installed.
- Action 1: Check the following in the Device Manager of the "System Properties" window. "NEC Electronics IE-PC Interface [MINICUBE2 USB]" is displayed.  $\bullet$  Alternatively, the "!" or " $\!\times\!\!"$  is not prefixed. If not, see the Trouble Du
- Cause 2: There may be an incorrect connection between the target cable and target system.
- Action 2: Check if the connections are correct. DATA pin of the MINICUBE2 → X2 pin of the target device.
   CLK pin of the MINICUBE2 → X1 pin of the target device.
- Cause 3: The power may not be correctly supplied to the target device.
- Action 3: Check that the power is supplied in the target system If the power is supplied from the MINICUBE2, check if the setting of the Mode select switch and Power select switch are correct.
- Cause 4: The PBM file selected in the "Device Setup" window may be incorrect
- Action 4: Download the latest PBM file (78F922x prm) from the following site Next, select it by clicking on PRM File Read in the "Device Setup" window.
  - NEC Electronics Microcontrollers and Microprocessors Website MINICUBE2 http://www.necel.com/micro/en/development/asia/minicube2/minicube2.html
  - "Development Tools Download" Version-up service http://www.necel.com/micro/ods/eng/index.html
- Cause 5: A security setting may have been made for the programming device.
- Action 5: A security setting may have been made for the programming device. For details, refer to Description of security flag in STEP5
- Cause 6: The power supply capacity of the USB port of the PC may be low (when the Power select switch is set to "3" or "5").
- Action 6: If the power select switch is set to "3" or "5", the power supply is 100 mA max., so a power shortage may occur. In such a case, set the power select switch to "T" and then supply power from the target system.

If problems are not solved by any of the above, the flash memory unit itself or the MINICUBE2 may be damaged.



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